



30V N-CHANNEL ENHANCEMENT MODE MOSFET PowerDI5060-8 (Type K)

Product Summary

BV _{DSS}	R _{DS(ON)}	I _D T _C = +25°C
30V	$1.6m\Omega$ @ $V_{GS} = 10V$	240A

Description

This new generation N-Channel Enhancement Mode MOSFET is designed to minimize $R_{DS(ON)}$, yet maintain superior switching performance. This device is ideal for use in power management and load switch.

Applications

- DC-DC Converters
- Load Switch

PowerDI5060-8 (Type K)





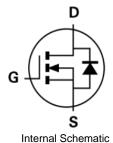


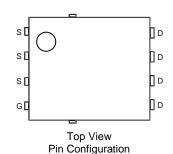
Features

- Thermally Efficient Package Cooler Running Applications
- <1.1mm Package Profile Ideal for Thin Applications
- High Conversion Efficiency
- Low R_{DS(ON)} Minimizes On-State Losses
- Low Input Capacitance
- Fast Switching Speed
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: PowerDI[®]5060-8 (Type K)
- Case Material: Molded Plastic, "Green" Molding Compound;
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Finish Matte Tin Annealed over Copper Leadframe;
 Solderable per MIL-STD-202, Method 208 3
- Weight: 0.097 grams (Approximate)





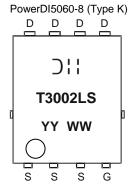
Ordering Information (Note 4)

7			
	Part Number	Case	Packaging
	DMT3002LPS-13	PowerDI5060-8 (Type K)	2,500/Tape & Reel

Notes:

- 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
- 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



☐ He Manufacturer's Marking
T3002LS = Product Type Marking Code
YYWW = Date Code Marking
YY = Last Two Digits of Year (ex: 17 = 2017)
WW = Week Code (01 to 53)

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Characteristic	Symbol	Value	Unit		
Drain-Source Voltage	V_{DSS}	30	V		
Gate-Source Voltage	V_{GSS}	±16	V		
Continuous Drain Current, V _{GS} = 10V (Note 7)	I_D	240 240	Α		
Maximum Continuous Body Diode Forward Current (Not	Is	100	Α		
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	I _{DM}	400	Α		
Pulsed Continuous Body Diode Forward Current (10µs P	I _{SM}	400	Α		
Avalanche Current, L=3mH (Note 8)			I _{AS}	15	Α
Avalanche Energy, L=3mH (Note 8)	E _{AS}	700	mJ		

Thermal Characteristics (@T_C = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)	$T_A = +25^{\circ}C$	P_D	1.2	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	$R_{ heta JA}$	103	°C/W
Total Power Dissipation (Note 6)	T _A = +25°C	P_D	2.5	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	$R_{\theta JA}$	51	°C/W
Total Power Dissipation (Note 7)	$T_C = +25^{\circ}C$	P_{D}	136	W
Thermal Resistance, Junction to Case (Note 7)		$R_{ heta JC}$	1.1	°C/W
Operating and Storage Temperature Range		$T_{J_i}T_{STG}$	-55 to +150	°C

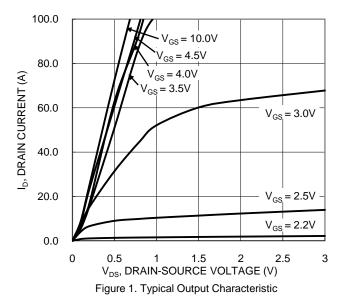
Electrical Characteristics (@T_C = +25°C, unless otherwise specified.)

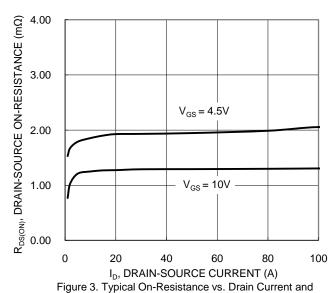
Characteristic	Symbol	Min	Tyro	Max	Unit	Test Condition	
Characteristic Symbol Min Typ Max Unit Test Condition OFF CHARACTERISTICS (Note 9)						rest Condition	
Drain-Source Breakdown Voltage	BV _{DSS}	30	_	_	V	$V_{GS} = 0V$, $I_D = 250 \mu A$	
Zero Gate Voltage Drain Current		_		1	μA		
5	I _{DSS}			.100	•	$V_{DS} = 24V, V_{GS} = 0V$	
Gate-Source Leakage	IGSS	_	_	±100	nA	$V_{GS} = \pm 16V$, $V_{DS} = 0V$	
ON CHARACTERISTICS (Note 9)				1			
Gate Threshold Voltage	V _{GS(TH)}	1	_	2	V	$V_{DS} = V_{GS}$, $I_D = 1mA$	
Static Drain-Source On-Resistance	D	_	1.25	1.6	mΩ	$V_{GS} = 10V, I_D = 25A$	
Static Drain-Source On-Resistance	R _{DS(ON)}	_	2	2.5	11122	$V_{GS} = 4.5V, I_D = 25A$	
Diode Forward Voltage	V _{SD}	_	0.8	1.1	V	V _{GS} = 0V, I _S = 25A	
DYNAMIC CHARACTERISTICS (Note 10)			•	•		•	
Input Capacitance	C _{ISS}	_	5,000	_		V _{DS} = 15V, V _{GS} = 0V, f = 1MHz	
Output Capacitance	Coss	_	2,660	_	pF		
Reverse Transfer Capacitance	C _{RSS}	_	300	_			
Gate Resistance	R _G	_	0.75	_	Ω $V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$		
Total Gate Charge (V _{GS} = 4.5V)	Q _G	_	37	_			
Total Gate Charge (V _{GS} = 10V)	Q_{G}	_	77	_	nC	V _{DS} = 15V, I _D = 25A	
Gate-Source Charge	Q _{GS}	_	10	_	iiC		
Gate-Drain Charge	Q_{GD}	_	14	_			
Turn-On Delay Time	t _{D(ON)}	_	21	_		$V_{DD} = 15V, V_{GS} = 4.5V,$ $I_{D} = 25A, R_{G} = 4.7\Omega$	
Turn-On Rise Time	t _R	_	45	_	20		
Turn-Off Delay Time	t _{D(OFF)}	_	32	_	ns		
Turn-Off Fall Time	t _F	_	26	_			
Body Diode Reverse Recovery Time	t _{RR}	_	44	_	ns	1 450 11/14 4000/	
Body Diode Reverse Recovery Charge	Q _{RR}	_	52	_	nC	$I_S = 15A$, di/dt = 100A/ μ s	

Notes:

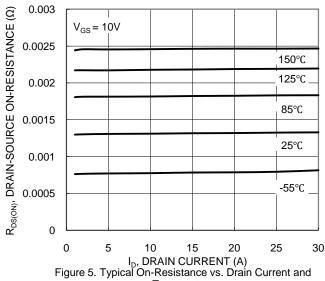
- 5. Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.
 6. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1-inch square copper plate.
 7. Thermal resistance from junction to soldering point (on the exposed drain pad).
 8. I_{AS} and E_{AS} ratings are based on low frequency and duty cycles to keep T_J = +25°C.
 9. Short duration pulse test used to minimize self-heating effect.
 10. Guaranteed by design. Not subject to product testing.



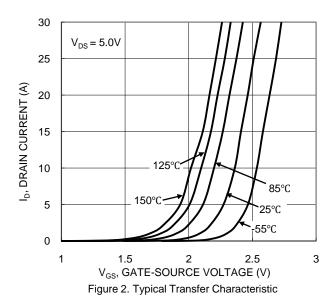


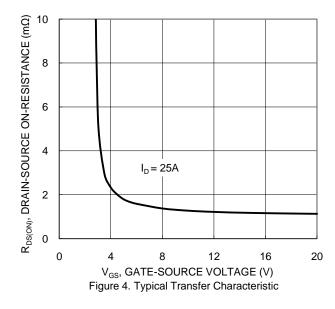


Gate Voltage



Temperature





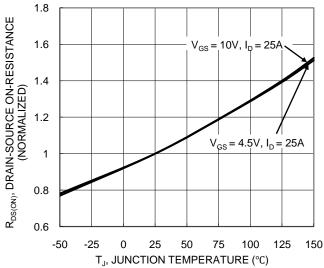


Figure 6. On-Resistance Variation with Temperature





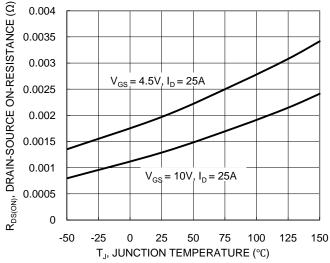


Figure 7. On-Resistance Variation with Temperature

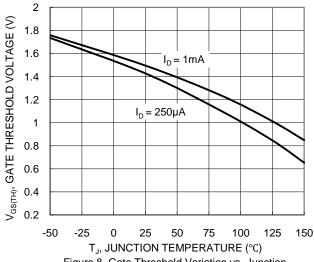


Figure 8. Gate Threshold Variation vs. Junction Temperature

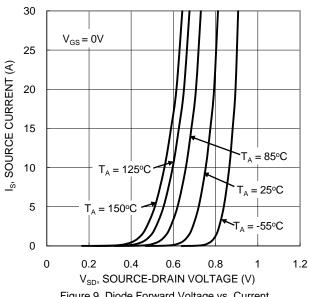
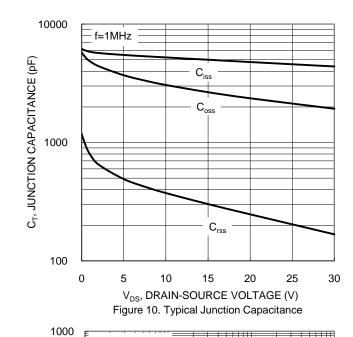
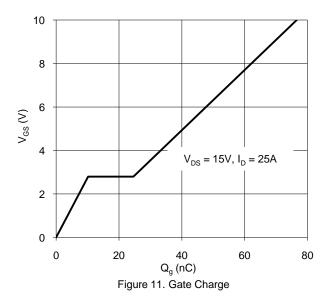


Figure 9. Diode Forward Voltage vs. Current





100 ID, DRAIN CURRENT (A) 10 $T_{J(MAX)}$ =150°C T_{C} =25°C P_w=100ms Single Pulse DUT on infinite heatsink V_{GS}=10V 0.01 10 100 0.1 V_{DS}, DRAIN-SOURCE VOLTAGE (V) Figure 12. SOA, Safe Operation Area

R_{DS(ON)} LIMITED



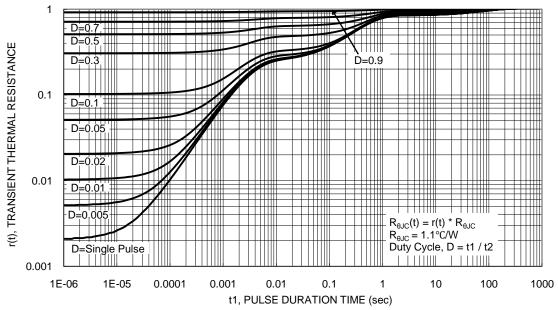


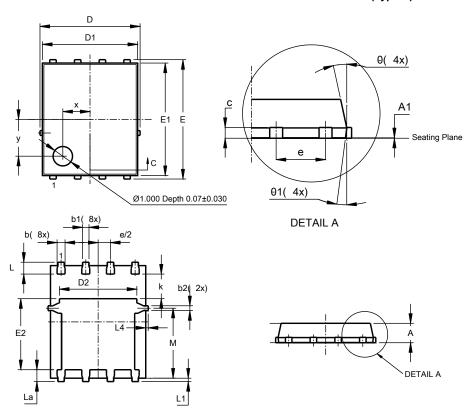
Figure 13. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5060-8 (Type K)

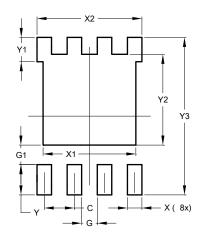


PowerDI5060-8							
(Type K)							
Dim	Min	Max	Тур				
Α	0.90	1.10	1.00				
A1	0	0.05	0.02				
b	0.33	0.51	0.41				
b1	0.300	0.366	0.333				
b2	0.20	0.35	0.25				
С	0.23	0.33	0.277				
D	5	.15 BS0	\sim				
D1	4.85	4.95	4.90				
D2	-	-	3.98				
Е	6	.15 BS0	2				
E1	5.75	5.85	5.80				
E2	3.56	3.725	3.66				
Е	1	.27BSC					
k	-	-	1.27				
L	0.51	0.71	0.61				
La	0.51	0.675	0.61				
L1	0.05	0.20	0.175				
L4	-	-	0.125				
М	3.50 3.71		3.605				
X	-	-	1.400				
У	-	-	1.900				
θ	10° 12°		11°				
θ1	θ1 6° 8° 7°						
All Dimensions in mm							

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5060-8 (Type K)



Dimensions	Value		
	(in mm)		
С	1.270		
G	0.660		
G1	0.820		
Х	0.610		
X1	3.910		
X2	4.420		
Υ	1.270		
Y1	1.020		
Y2	3.810		
Y3	6.610		



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